

TOSHIBA Field Effect Transistor Silicon N Channel MOS Type (π -MOSV)

2SK3313

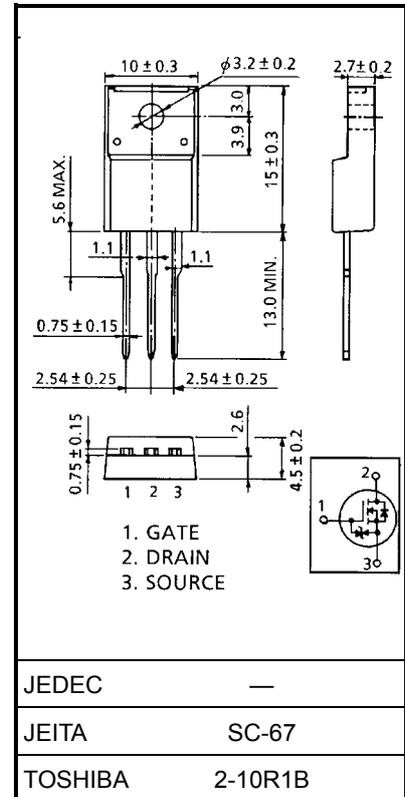
Chopper Regulator, DC-DC Converter Applications
Motor Drive Applications

Unit: mm

- Fast reverse recovery time : $t_{rr} = 90 \text{ ns (typ.)}$
- Built-in high-speed free-wheeling diode
- Low drain-source ON resistance : $R_{DS(ON)} = 0.5 \Omega \text{ (typ.)}$
- High forward transfer admittance : $|Y_{fs}| = 8.5 \text{ S (typ.)}$
- Low leakage current : $I_{DSS} = 100 \mu\text{A (max)}$ ($V_{DS} = 500 \text{ V}$)
- Enhancement-mode : $V_{th} = 2.0\sim 4.0 \text{ V}$ ($V_{DS} = 10 \text{ V}$, $I_D = 1 \text{ mA}$)

Maximum Ratings ($T_a = 25^\circ\text{C}$)

Characteristics	Symbol	Rating	Unit
Drain-source voltage	V_{DSS}	500	V
Drain-gate voltage ($R_{GS} = 20 \text{ k}\Omega$)	V_{DGR}	500	V
Gate-source voltage	V_{GSS}	± 30	V
Drain current	DC (Note 1)	I_D	12 A
	Pulse (Note 1)	I_{DP}	48 A
Drain power dissipation ($T_c = 25^\circ\text{C}$)	P_D	40	W
Single pulse avalanche energy (Note 2)	E_{AS}	324	mJ
Avalanche current	I_{AR}	12	A
Repetitive avalanche energy (Note 3)	E_{AR}	4.0	mJ
Channel temperature	T_{ch}	150	$^\circ\text{C}$
Storage temperature range	T_{stg}	-55~150	$^\circ\text{C}$



Weight: 1.9 g (typ.)

Thermal Characteristics

Characteristics	Symbol	Max	Unit
Thermal resistance, channel to case	$R_{th(ch-c)}$	3.125	$^\circ\text{C/W}$
Thermal resistance, channel to ambient	$R_{th(ch-a)}$	62.5	$^\circ\text{C/W}$

Note 1: Please use devices on condition that the channel temperature is below 150°C .

Note 2: $V_{DD} = 90 \text{ V}$, $T_{ch} = 25^\circ\text{C}$ (initial), $L = 3.83 \text{ mH}$, $R_G = 25 \Omega$, $I_{AR} = 12 \text{ A}$

Note 3: Repetitive rating; Pulse width limited by maximum channel temperature.

This transistor is an electrostatic sensitive device.

Please handle with caution.

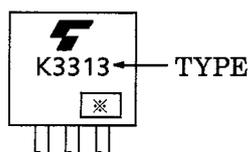
Electrical Characteristics (Ta = 25°C)

Characteristics		Symbol	Test Condition	Min	Typ.	Max	Unit
Gate leakage current		I_{GSS}	$V_{GS} = \pm 25\text{ V}, V_{DS} = 0\text{ V}$	—	—	± 10	μA
Gate-source breakdown voltage		$V_{(BR)GSS}$	$I_G = \pm 100\ \mu\text{A}, V_{DS} = 0\text{ V}$	± 30	—	—	V
Drain cut-off current		I_{DSS}	$V_{DS} = 500\text{ V}, V_{GS} = 0\text{ V}$	—	—	100	μA
Drain-source breakdown voltage		$V_{(BR)DSS}$	$I_D = 10\text{ mA}, V_{GS} = 0\text{ V}$	500	—	—	V
Gate threshold voltage		V_{th}	$V_{DS} = 10\text{ V}, I_D = 1\text{ mA}$	2.0	—	4.0	V
Drain-source ON resistance		$R_{DS(ON)}$	$V_{GS} = 10\text{ V}, I_D = 6\text{ A}$	—	0.5	0.62	Ω
Forward transfer admittance		$ Y_{fs} $	$V_{GS} = 10\text{ V}, I_D = 6\text{ A}$	3.0	8.5	—	S
Input capacitance		C_{iss}	$V_{DS} = 10\text{ V}, V_{GS} = 0\text{ V}, f = 1\text{ MHz}$	—	2040	—	pF
Reverse transfer capacitance		C_{rss}		—	210	—	
Output capacitance		C_{oss}		—	630	—	
Switching time	Rise time	t_r		—	22	—	ns
	Turn-on time	t_{on}		—	58	—	
	Fall time	t_f		—	36	—	
	Turn-off time	t_{off}		—	180	—	
Total gate charge (Gate-source plus gate-drain)		Q_g	$V_{DD} \approx 400\text{ V}, V_{GS} = 10\text{ V}, I_D = 12\text{ A}$	—	45	—	nC
Gate-source charge		Q_{gs}		—	25	—	
Gate-drain ("miller") charge		Q_{gd}		—	20	—	

Source-Drain Ratings and Characteristics (Ta = 25°C)

Characteristics	Symbol	Test Condition	Min	Typ.	Max	Unit
Continuous drain reverse current (Note 1)	I_{DR}	—	—	—	12	A
Pulse drain reverse current (Note 1)	I_{DRP}	—	—	—	48	A
Forward voltage (diode)	V_{DSF}	$I_{DR} = 12\text{ A}, V_{GS} = 0\text{ V}$	—	—	-1.7	V
Reverse recovery time	t_{rr}	$I_{DR} = 12\text{ A}, V_{GS} = 0\text{ V}$	—	90	160	ns
Reverse recovery charge	Q_{rr}	$dI_{DR} / dt = 100\text{ A} / \mu\text{s}$	—	0.25	—	μC

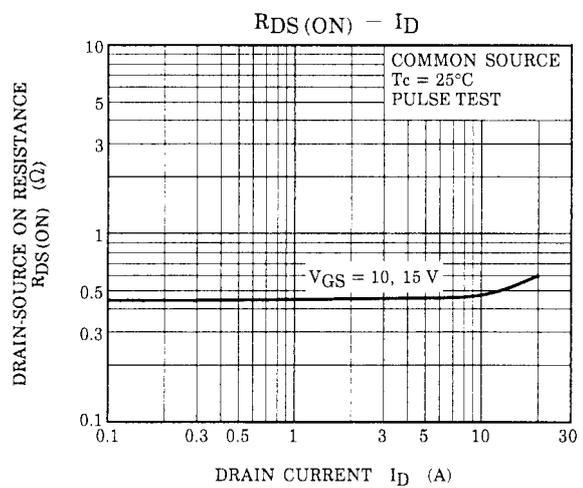
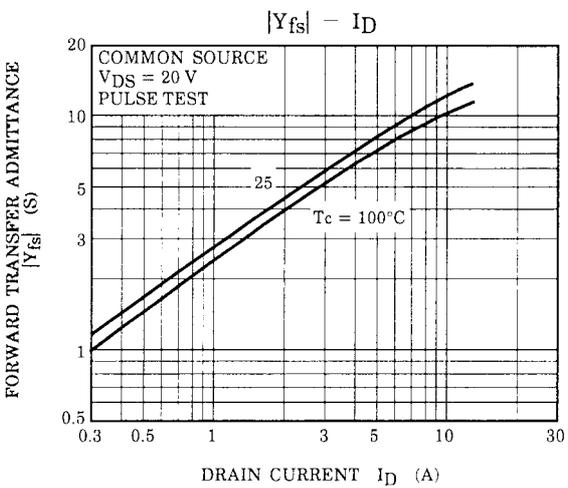
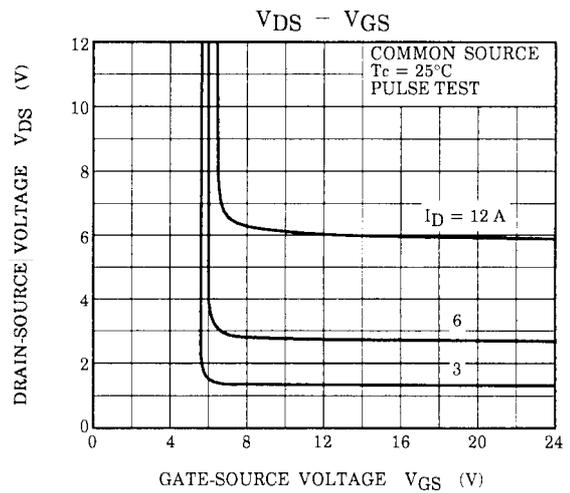
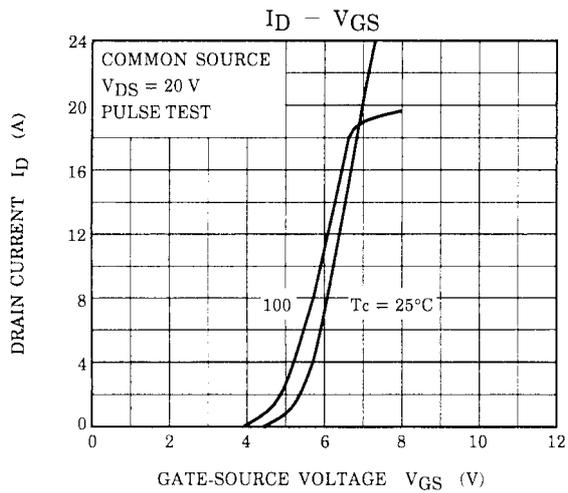
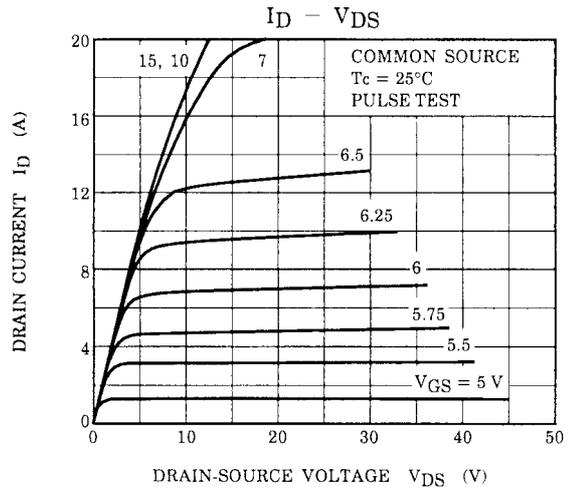
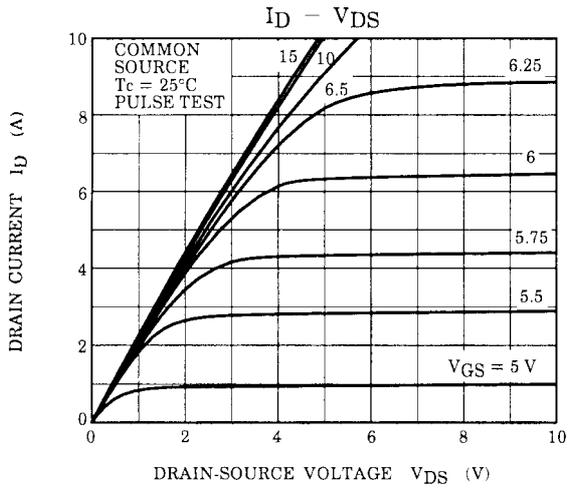
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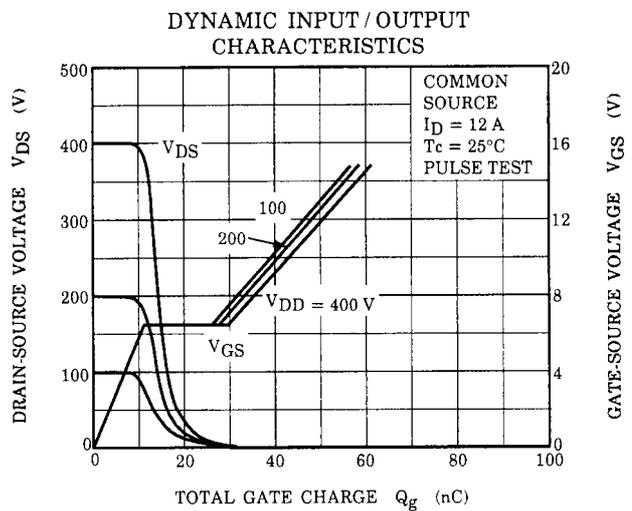
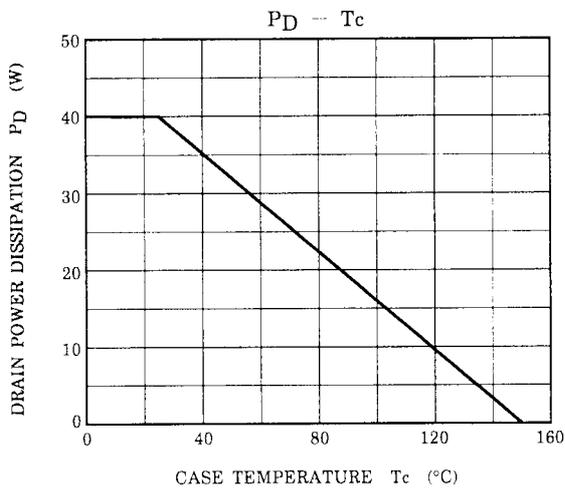
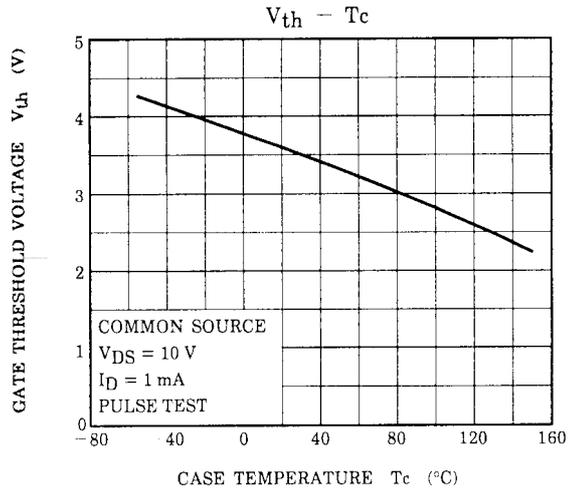
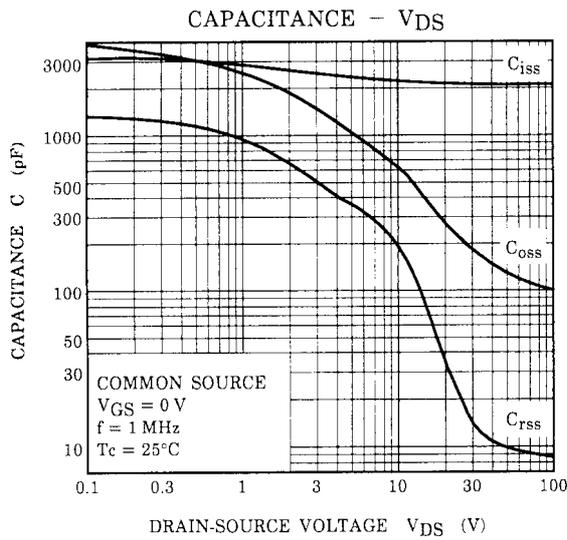
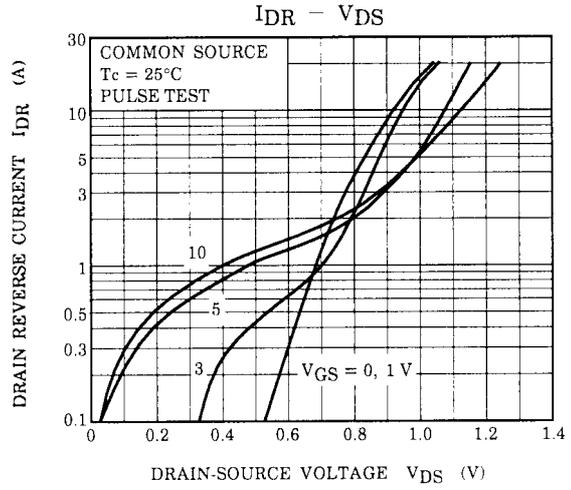
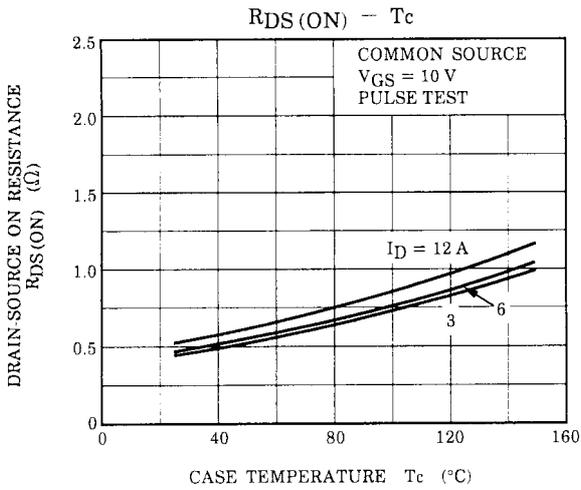


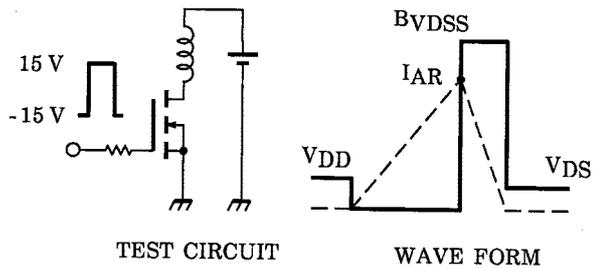
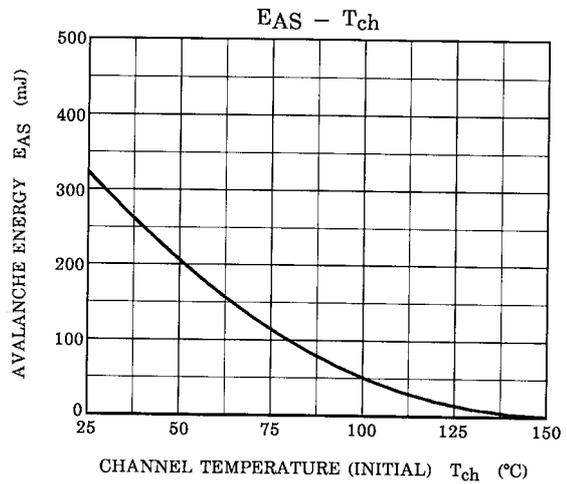
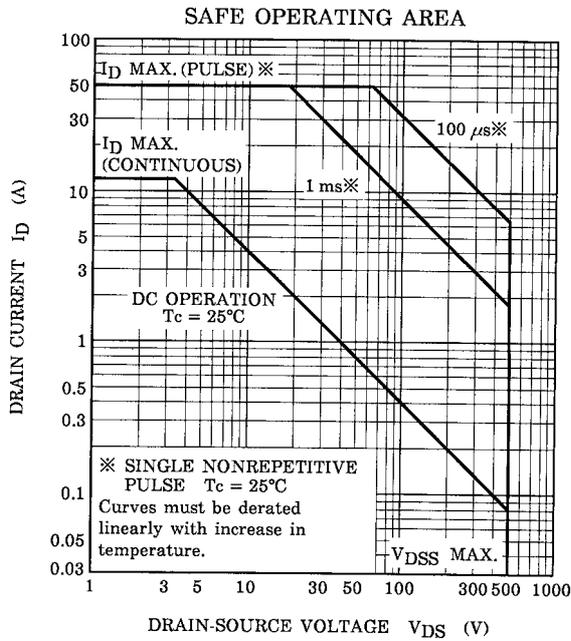
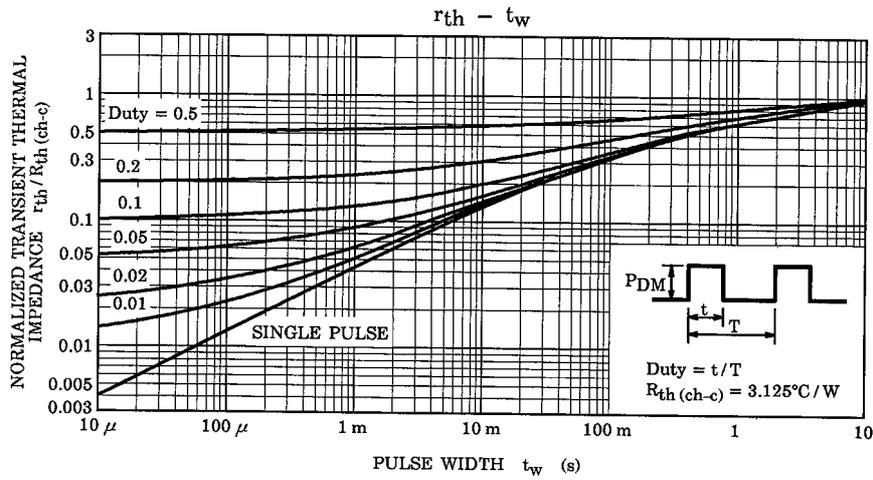
※ Lot Number

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— Year (Last Number of the Christian Era)







$$R_G = 25 \Omega$$

$$V_{DD} = 90 \text{ V}, L = 3.83 \text{ mH}$$

$$EAS = \frac{1}{2} \cdot L \cdot I^2 \cdot \left(\frac{BVDSS}{BVDSS - V_{DD}} \right)$$

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